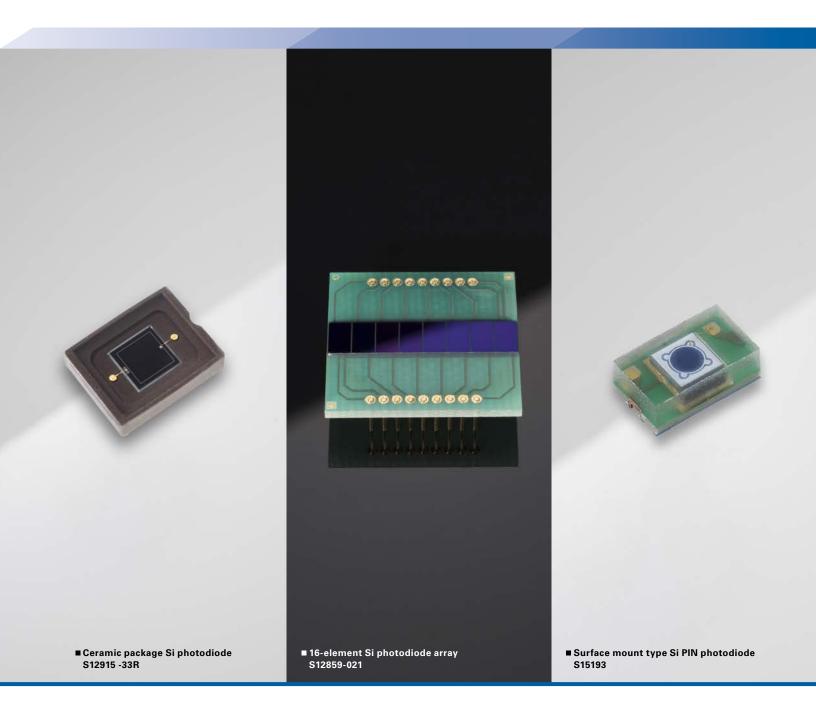


# Si Photodiodes

Lineup of Si photodiodes for UV to near IR, radiation



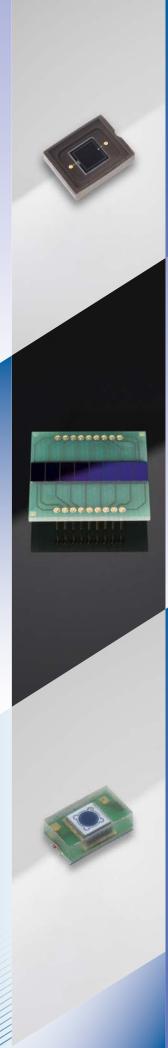
# Si Photodiodes

Lineup of Si photodiodes for UV to near IR, radiation



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## Si photodiodes

Photodiodes are semiconductor light sensors that generate a current or voltage when the P-N junction in the semiconductor is illuminated by light. The term photodiode can be broadly defined to include even solar batteries, but it usually refers to sensors used to detect the intensity of light. Photodiodes can be classified by function and construction as follows:

- Si photodiode
- Si PIN photodiode
- Si APD (avalanche photodiode)

All of these types provide the following features and are widely used for the detection of the presence, intensity and color of light.

- Excellent linearity with respect to incident light
- Low noise
- Wide spectral response range
- Mechanically rugged
- · Compact and lightweight
- Long life

Si photodiodes manufactured utilizing our unique semiconductor process technologies cover a broad spectral range from the near infrared to ultraviolet and even to high-energy regions. They also feature high-speed response, high sensitivity and low noise. Si photodiodes are used in a wide range of applications including medical and analytical fields, scientific measurements, optical communications and general electronic products. Si photodiodes are available in various packages such as metal, ceramic and plastic packages as well as in surface mount types. We also offer custom-designed devices to meet special needs.

#### ◆ Hamamatsu Si photodiodes

Туре	Feature	Product example
Si photodiode	Featuring high sensitivity and low dark current, these Si photodiodes are specifically designed for precision photometry and general photometry/visible range.	For UV to near IR For visible range to near IR For visible range RGB color sensor For monochromatic light detection For VUV (vacuum ultraviolet) detection For electron beam detector
Si PIN photodiode	Si PIN photodiodes delivering high-speed response when operated with a reverse bias are widely used for optical communications and optical disk pickup, etc.	Cutoff frequency: 1 GHz or more     Cutoff frequency: 100 MHz to less than 1 GHz     Cutoff frequency: 10 MHz to less than 100 MHz     For YAG laser detection
Multi-element type Si photodiode	Si photodiode arrays consist of multiple elements of the same size, formed at an equal spacing in one package. These Si photodiode arrays are used in a wide range of applications such as laser beam position detection and spectrophotometry.	<ul><li>Segment type</li><li>One-dimensional type</li></ul>
Si photodiode with preamp, TE-cooled type Si photodiode	Si photodiodes with preamp incorporate a photodiode and a pre-amplifier chip into the same package. Since TE-cooled type Si photodiodes include TE-cooler in a package, they achieve excellent S/N.	<ul> <li>For analytical and measurement</li> </ul>
Si photodiode for X-ray detection	These detectors are comprised of a Si photodiode coupled to a scintillator. These detectors are used for X-ray baggage inspection and non-destructive inspection.	With scintillator     Large area Si PIN photodiodes
Si APD*	Si APDs are high-speed, high sensitivity photodiodes having an internal gain mechanism.	<ul><li>Near IR type</li><li>Short wavelength type</li><li>Multi-element type</li></ul>
Related product of Si photodiode	Hamamatsu provides various types of Si photodiode modules.	RGB color sensor module Color sensor evaluation circuit Driver circuit for Si photodiode array Photodiode module Signal processing unit for photodiode module Photosensor amplifier Charge amplifier

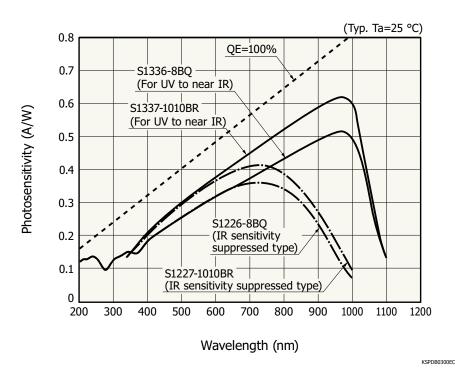
<sup>\*</sup> Si APD is not listed in this catalogue.

Note: Hamamatsu also provides PSD (position sensitive detector) used to detect the position of incident light spot. PSD is a non-discrete photosensor utilizing the surface resistance of photodiodes.

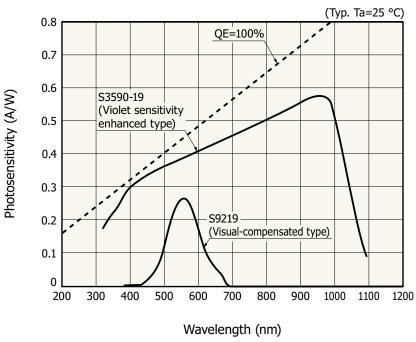
## Spectral response (typical example)

Hamamatsu provides a lineup that covers a variety of spectral response ranges from 200 nm to 1200 nm.

#### [ S1226/S1336-8BQ, S1227/S1337-1010BR ]



[ S3590-19, S9219 ]



KSPDB0301EC

## **Packages**

Hamamatsu provides a wide variety of packages including metal, ceramic, and plastic.

#### ◆ Si photodiodes for precision photometry

Туре	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
	S1336 series	9	Yes					
5 104: 15	S1337 series (excluding S1337-21)	9		Yes				
For UV to near IR	S1337-21	10		Yes				Unsealed
	S2551	10		Yes				
	S2281 series	10					Yes	
For UV to near IR	S1226 series	11	Yes					
(IR sensitivity	S1227 series	11		Yes				
suppressed type)	S2281-01	11					Yes	
For UV monitor	S12698 series	12	Yes					
For visible range to	S2386 series	13	Yes					
near IR	S12915 series	14		Yes				

## ◆ Si photodiodes for general photometry/visible range

	Туре	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
	Visual-sensitive compensated	S1087, S1133, S8265	15		Yes				
For		S1787-04	15			Yes			
visible	CIE standard	S9219	15					Yes	
range	luminous efficiency approximation	S9219-01	15	Yes					
		S7686	15		Yes				
For visit	ole range to	S1787-12, S4797-01 S4011-06DS S1787-08, S2833-01	16			Yes			
near IR		S1133-14, S1087-01 S1133-01	16		Yes				

## ♦ High-speed response Si PIN photodiodes

Type	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
Cutoff frequency: 1 GHz or more	utoff frequency: S5973/S9055 series		Yes					
Cutoff frequency: 100 MHz to less	S5971, S3399 S3883, S5972	18	Yes					
than 1 GHz	S10783, S10784	18			Yes			
Cutoff frequency: 10 MHz to less than	\$6775/\$8729/ \$2506 series \$6967, \$8385 \$4707-01, \$6801-01	19			Yes			
100 MHz	S5821/S1223 series S3071, S3072 S12271	20	Yes					

## ♠ Multi-element type Si photodiodes

Type	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
Segmented type	S3096-02, S4204, S9345	21			Yes			
Si PIN photodiode	S4349	21	Yes					
	S4111/S4114 series	22		Yes				
One-dimensional photodiode array	\$12858/\$12859/ \$11212/\$11299/ \$12362/\$12363-021	22				Yes		Unsealed

## ◆ Surface mount type Si photodiodes

Туре	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
High-speed response Si PIN photodiode	S5106, S5107 S7509, S7510	23		Yes				Surface mount type
Segmented type Si photodiode	S5980, S5981, S5870 S8558, S15158	23		Yes		Yes		Surface mount type
Small package type Si photodiode	S9674, S9981-01CT S10625-01CT	24				Yes		Surface mount type
Small package type Si PIN photodiode	\$13773 \$10993-02CT, \$12158-01CT \$13954-01CT, \$14016-01DT	25				Yes		Surface mount type

## ◆ Si photodiodes with preamp, TE-cooled type Si photodiodes

Type	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
	S8745-01, S8746-01 S9295 series	26	Yes					
TE-cooled type Si photodiode	S2592/S3477 series	27	Yes					

## ◆ Si photodiodes for X-ray detection

Type	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
Si photodiode with scintillator	S8559, S8193	28		Yes				With scintillator
	\$12858/\$12859/ \$11299/\$11212/ \$12362/\$12363 series	28				Yes		With scintillator
Large area type	S3590 series S8650	30		Yes				
Large area type Si PIN photodiode	S2744/S3204/ S3584/S3588 series	31		Yes				
Large area type Si PIN photodiodes for direct radiation detection	S13993, S14605	32		Yes				Unsealed

## ◆ Special application Si photodiodes

Type	Type no.	Page	Metal	Ceramic	Plastic	Glass epoxy	With BNC connector	Remarks
	S7505-01, S9032-02 S9702	33			Yes			Surface mount type
RGB color sensor	S10917-35GT S10942-01CT	33				Yes		Surface mount type
	S6428-01, S6429-01 S6430-01	34			Yes			
Violet/blue sensitivity	S5973-02, S9195	35	Yes					
enhanced type	S3994-01	35		Yes				
For VUV (vacuum ultraviolet) monitor	S8552, S8553	36		Yes				Unsealed
For VUV detection (high reliability type)	S10043	36		Yes				Unsealed
For monochromatic light detection	S12742 series	37	Yes					
For YAG laser detection	S3759	37	Yes					
For electron beam detector	S11141 series	38		Yes				Unsealed
PWB package with leads type	S12497, S12498	38				Yes		Unsealed
CSP type	S13955-01, S13956-01 S13957-01	39				Yes		Unsealed
CSP type 64-element Si photodiode array	S13620-02	39				Yes		Unsealed
6-element array for encoder	S14833	39				Yes		Surface mount type

#### Variety of package types

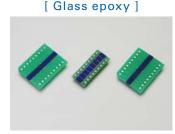
Hamamatsu offers a diverse selection of package types to meet different customer needs. Metal packages are widely used in applications requiring high reliability. Ceramic packages are used for general applications and plastic packages are used in applications where the main need is low cost.

Other types are also available including those with BNC connector, which facilitates connection to coaxial cable, surface mount types that support reflow soldering, and those with scintillator, which converts X-rays and radiation to visible light.



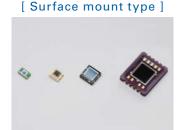




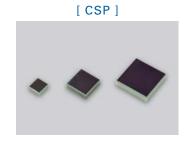


[ With BNC connector ]





[ With scintillator ]



#### Mount technology

At the Solid State Division of Hamamatsu Photonics, we are constantly at work designing and developing our own mount technology to offer unique semiconductor devices having special features.

Now we will take a brief look at our mount technology for Si photodiodes.

## Flip chip bonding

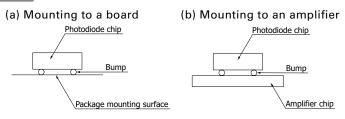
Mounting technology for opto-semiconductors includes not only the two-stage chip die-bonding and wire-bonding but also the flip chip bonding as shown in Figure 1.

Parasitic capacitance and inductance can be a problem when extracting opto-semiconductor device signals from a wire. Flipchip bonding can prevent this problem and help in downsizing since it utilizes bumps to directly join the chip to the package or an IC chip, etc.

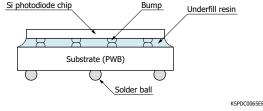
#### ▲ CSP (chip size package)

In CSP type photodiodes, the chip and substrate are connected by bump electrodes so there is minimal dead area on the package surface area. This allows utilizing the photosensitive area more effectively. Also multiple devices can be densely arrayed and used in a tile format. There is no wiring so coupling to the scintillator is easy.

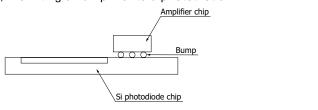
## Figure 1 Example of flip chip bonding



#### Figure 2 Cross section of CSP type photodiode Si photodiode chip



(c) Mounting an amplifier to a photodiode



KSPDC0060EA

## Application examples

Here, we will introduce several applications of our Si photodiodes.

### Optical power meters



Large area type Si PIN photodiodes are used to measure the light levels of various light sources such as laser diodes and LEDs.

## Sunlight sensors



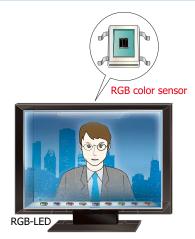
Si photodiodes are used to detect the amount of sunshine to control the volume of air flow for automotive air conditioners.

#### Radiation detectors



Si PIN photodiodes with scintillators are used in detectors that measure radiation levels of  $\gamma$  rays and other rays.

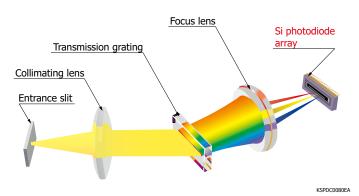
## LCD backlight color adjustment



KSPDC0077FA

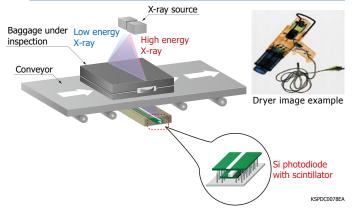
The RGB color sensor detects the white balance of LCD backlight optical waveguides and controls the light level of each RGB LED to stabilize the LCD backlight color.

### Spectrophotometers



Si photodiode arrays are used to detect light that has been divided into wavelengths through a diffraction grating in spectrophotometers.

#### Baggage inspection equipment



Si PIN photodiodes with scintillators are used in dual energy imaging of baggage inspection equipment to obtain information about an object such as its type and thickness.

## Si photodiodes for precision photometry

## For UV to near IR

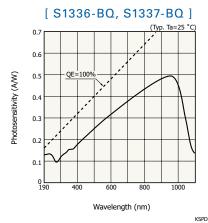
These Si photodiodes have sensitivity in the UV to near IR range. They are suitable for low-light-level detection in analysis and the like.

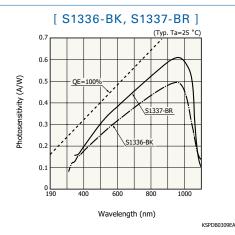
(Typ. Ta=25 °C)

Туре по.	Spectral response range	(Λ/\Λ/\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			Photosensitive area size	Package	Photo					
	(nm)	λ=200 nm	λ=960 nm	(pA)	(pF)	(mm)						
S1336-18BQ*1	190 to 1100	0.12		20	20	1.1 × 1.1	TO-18	<b>3</b>				
S1336-18BK	320 to 1100	-		20	20	1.1 × 1.1	10-16	4				
S1336-5BQ*1	190 to 1100	0.12	0.5	0.5	0.5	0.5	0.5	30	65	2.4 × 2.4		
S1336-5BK	320 to 1100	-						30	05	2.4 × 2.4	TO-5	
S1336-44BQ*1	190 to 1100	0.12	0.5	50	150	3.6 × 3.6	10-5					
S1336-44BK	320 to 1100	-	50	150	3.0 × 3.0		100					
S1336-8BQ*1	190 to 1100	0.12		100	380	5.8 × 5.8	TO-8					
S1336-8BK	320 to 1100	-		100	360	0.6 × 5.6	10-6	9				
S1337-16BQ*1	190 to 1100	0.12	0.5	50		1.1 × 5.9						
S1337-16BR	340 to 1100	-	0.62	50	65	1.1 × 5.9						
S1337-33BQ*1	190 to 1100	0.12	0.5	30	05	2.4 × 2.4						
S1337-33BR	340 to 1100	-	0.62	30		2.4 × 2.4	Ceramic					
S1337-66BQ*1	190 to 1100	0.12	0.5	100	380	5.8 × 5.8	Ceramic					
S1337-66BR	340 to 1100	-	0.62	100	360	0.0 x 0.0						
S1337-1010BQ*1	190 to 1100	0.12	0.5	200	1100	10 × 10						
S1337-1010BR	340 to 1100	-	0.62	200	1100	10 × 10						

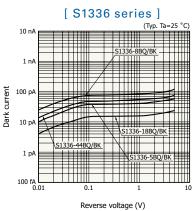
<sup>\*1:</sup> Refer to "Precautions against UV light exposure" (P.45).

## Spectral response

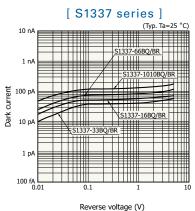




#### Dark current vs. reverse voltage



KSPDB0100EB



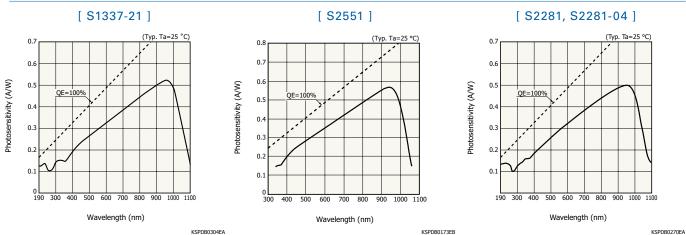
KSPDB0104EB

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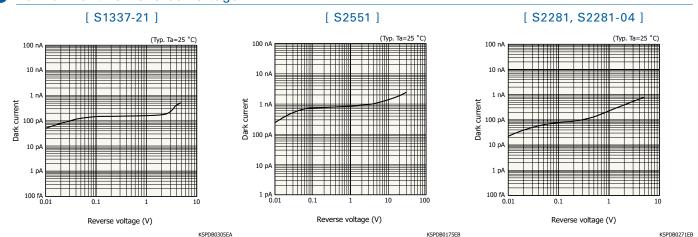
(Typ. Ta=25 °C)

Type no.	Spectral response range (nm)	(A/	nsitivity W) λ=960 nm	Dark current VR=10 mV max. (pA)	Terminal capacitance VR=0 V f=10 kHz (pF)	Photosensitive area size (mm)	Package	Photo
S1337-21* <sup>2</sup>	190 to 1100	0.13	0.52	500	4000	18 × 18	Ceramic (unsealed)	
S2551	340 to 1060	-	0.57 (λ=920 nm)	1000	350	1.2 × 29.1	Ceramic	
S2281*2 *3	100 to 1100	0.12	0.5	E00	1200	φ11.3	With BNC	0
S2281-04* <sup>2</sup> * <sup>3</sup>	190 to 1100	0.12	0.5	500	1300	φ7.98	connector	

### Spectral response



## Dark current vs. reverse voltage



<sup>\*2:</sup> Refer to "Precautions against UV light exposure" (P.45).
\*3: Connecting a photodiode to the C9329 photosensor amplifier (using a BNC-BNC coaxial cable E2573) allows amplifying the photodiode's weak photocurrent with low noise.

#### For UV to near IR (IR sensitivity suppressed type)

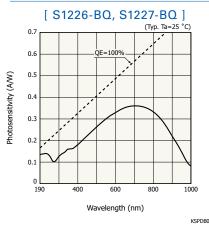
These Si photodiodes have suppressed IR sensitivity. They are suitable for low-light-level detection in analysis and the like.

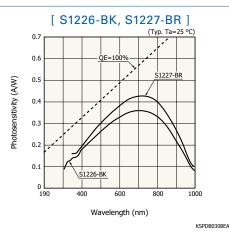
(Typ. Ta=25 °C)

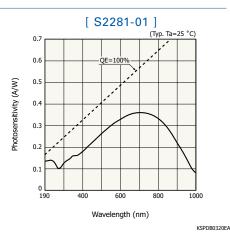
Type no.	Spectral response range	10	nsitivity W)	Dark current VR=10 mV max.	Terminal capacitance VR=0 V f=10 kHz	Photosensitive area size	Package	Photo
	(nm)	λ=200 nm	λ=720 nm	(pA)	(pF)	(mm)		
S1226-18BQ*1	190 to 1000	0.12		2	35	1.1 × 1.1	TO-18	8
S1226-18BK	320 to 1000	-		2	35	1.1 × 1.1	10-16	
S1226-5BQ*1	190 to 1000	0.12		5	160	2.4 × 2.4		
S1226-5BK	320 to 1000	-			100	2.4 \ 2.4	TO-5	
S1226-44BQ*1	190 to 1000	0.12	0.36	10	500	3.6 × 3.6	10 0	
S1226-44BK	320 to 1000	-		10	300	0.0 × 0.0		
S1226-8BQ*1	190 to 1000	0.12		20	1200	5.8 × 5.8	TO-8	
S1226-8BK	320 to 1000	-		20	1200	J.6 × J.6	10-8	
S1227-16BQ*1	190 to 1000	0.12	0.36		170	1.1 × 5.9		
S1227-16BR	340 to 1000	-	0.43	5	170	1.1 × 5.5		
S1227-33BQ*1	190 to 1000	0.12	0.36	3	160	2.4 × 2.4		·
S1227-33BR	340 to 1000	-	0.43		100	2.4 \ 2.4	Ceramic	
S1227-66BQ*1	190 to 1000	0.12	0.36	20	950	5.8 × 5.8	Ceramic	
S1227-66BR	340 to 1000	-	0.43	20	330	3.0 × 3.0		
S1227-1010BQ*1	190 to 1000	0.12	0.36	50	3000	10 × 10		
S1227-1010BR	340 to 1000	-	0.43	50	3000	10 × 10		
S2281-01*1	190 to 1000	0.12	0.36	300	3200	ф11.3	With BNC connector	0

<sup>\*1:</sup> Refer to "Precautions against UV light exposure" (P.45).

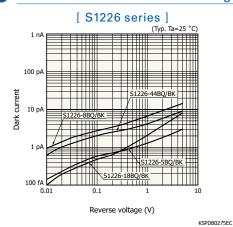
#### Spectral response

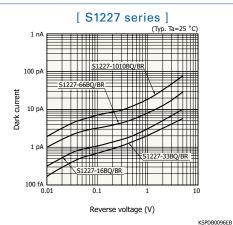


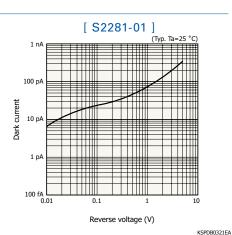




#### Dark current vs. reverse voltage









#### For UV monitor

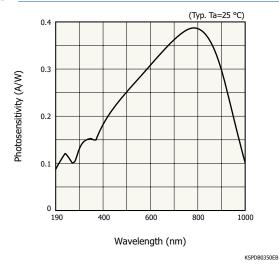
The S12698 series are Si photodiodes that have achieved high reliability for monitoring ultraviolet light by employing a structure that does not use resin. They exhibit low sensitivity deterioration under UV light irradiation and are suitable for applications such as monitoring intense UV light sources.

(Typ. Ta=25 °C)

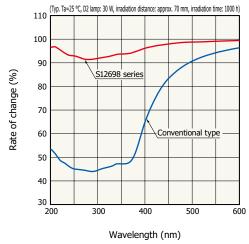
Type no.	Photosensitivity $\lambda = \lambda p$	Dark current VR=10 mV max.	Photosensitive area size	Package	Photo
S12698* <sup>2</sup>	(A/W)	(pA) 10	(mm) 1.1 × 1.1	TO-18	
S12698-01* <sup>2</sup>		30	2.4 × 2.4	TO 5	9
NEW S12698-04*2	- 0.38	50	3.6 × 3.6	TO-5	
S12698-02* <sup>2</sup>		100	5.8 × 5.8	TO-8	

<sup>\*2:</sup> Refer to "Precautions against UV light exposure ①" (P.45).

### Spectral response



## Changes in spectral response after irradiated with UV light



KSPDB0355EA

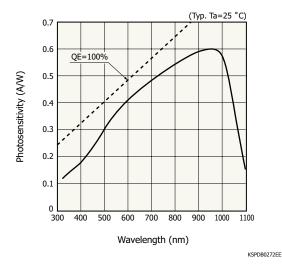
## For visible range to near IR

These Si photodiodes offer enhanced sensitivity especially in the near IR range.

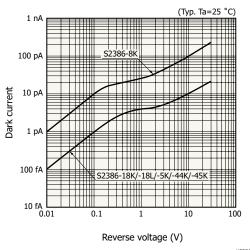
(Typ. Ta=25 °C)

Type no.	Spectral response range (nm)	Photosensitivity $\lambda$ =960 nm (A/W)	Dark current VR=10 mV max. (pA)	Terminal capacitance VR=0 V f=10 kHz (pF)	Photosensitive area size (mm)	Package	Photo
S2386-18K			2	140	1.1 × 1.1	TO-18	
S2386-18L			2	140	1.1 ~ 1.1	10-16	8
S2386-5K	320 to 1100	0.6	5	730	2.4 × 2.4		
S2386-44K	320 to 1100	0.6	20	1600	3.6 × 3.6	TO-5	
S2386-45K			30	2300	3.9 × 4.6		
S2386-8K			50	4300	5.8 × 5.8	TO-8	

## Spectral response



### Dark current vs. reverse voltage



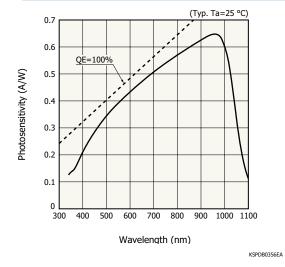
KSPDB0113EE



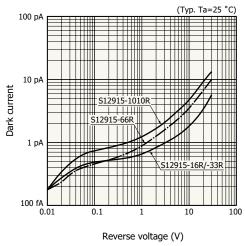
Typ. Ta=25 °C)

							(Typ. Ta=25 °C)
Type no.	Spectral response range (nm)	Photosensitivity λ=960 nm (A/W)	Dark current VR=10 mV max. (pA)	Terminal capacitance VR=0 V f=10 kHz (pF)	Photosensitive area size (mm)	Package	Photo
S12915-16R			5	740	1.0 × 6.0		
S12915-33R	240 to 1100	0.64	5	680	2.4 × 2.4	Coromia	
S12915-66R	340 to 1100	0.64	50	4000	5.8 × 5.8	Ceramic	
S12915-1010R			200	13000	10 × 10		

#### Spectral response



## Dark current vs. reverse voltage



KSPDB0365EA

## Si photodiodes for general photometry/visible range

## For visible range

These Si photodiodes have sensitivity in the visible range.

(Typ. Ta=25 °C)

Туре по.	Spectral response range		Photosensitivity $\lambda = \lambda p$	Dark current VR=1 V max.	Photosensitive area size	Package	Photo
	(nm)	(nm)	(A/W)	(pA)	(mm)		

#### Filter type (general use)

These are Si photodiodes with visible-compensated filters. The S8265 is a high humidity resistance type of the S1133.

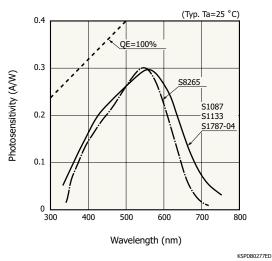
S1087	320 to 730	560		10	1.3 × 1.3	Ceramic	
S1133	320 10 730	300	0.3	10	2.4 × 2.8	Ceramic	
S8265	340 to 720	540	0.3	20	2.4 × 2.8	Ceramic	6
S1787-04	320 to 730	560		10	2.4 × 2.8	Plastic	

#### Filter type (CIE spectral luminous efficiency approximation)

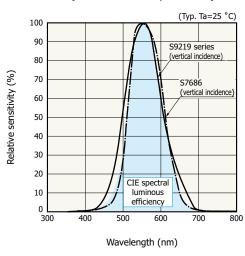
S9219	380 to 780		0.24	500 (VR=10 mV)	φ11.3	With BNC connector	<b>S</b>
S9219-01		550	0.22	50 (VR=10 mV)	3.6 × 3.6	TO-5	
S7686	480 to 660		0.38	20	2.4 × 2.8	Ceramic	

#### Spectral response

#### [ S1087, S1133, S1787-04, S8265 ]



#### [ \$9219 series, \$7686 ]



KSPDB0285EE



## For visible range to near IR

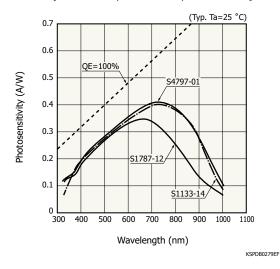
These Si photodiodes have sensitivity in the visible range to near IR.

(Typ. Ta=25 °C)

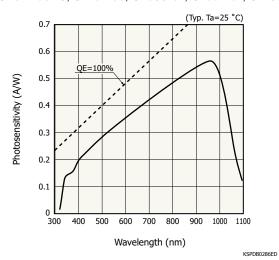
Type no.	Spectral response range (mm)	Peak sensitivity wavelength (mm)	Photosensitivity $\lambda = \lambda p$ (mm)	Dark current VR=1 V max. (pA)	Photosnsitive area size (mm)	Package	Photo
S1787-12		650	0.35		2.4 × 2.8	Dlastia	
S4797-01	320 to 1000	700	0.4	20	1.3 × 1.3	Plastic	4
S1133-14		720	0.4		2.4 × 2.8	Ceramic	
S4011-06DS					1.3 × 1.3		
S1787-08					2.4 × 2.8	Plastic	
S2833-01	320 to 1100	960	0.58	10	2.4 ^ 2.0		55
S1087-01					1.3 × 1.3	Ceramic	
S1133-01					2.4 × 2.8		

### Spectral response

#### [ S1787-12, S4797-01, S1133-14 ]



#### [ \$4011-06DS, \$1787-08, \$2833-01, \$1087-01, \$1133-01 ]



## High-speed response Si PIN photodiodes

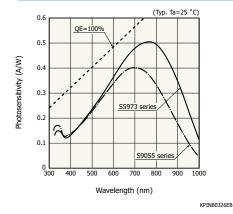
## Cutoff frequency: 1 GHz or more

These Si PIN photodiodes deliver a wide bandwidth even with a low bias, making them suitable for high-speed photometry as well as optical communications.

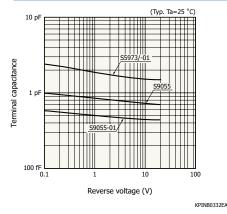
(Typ. Ta=25 °C)

Type no.	Cutoff frequency	Photosensitive area size	Photose (A/	nsitivity W)	Terminal capacitance f=1 MHz	Package	Photo
	(GHz)	(mm)	λ=780 nm	λ=830 nm	(pF)		
S5973 S5973-01	1 (VR=3.3 V)	φ0.4	0.51	0.47	1.6 (VR=3.3 V)		
S9055	1.5 (VR=2 V)	ф0.2	0.35	0.25	0.8 (VR=2 V)	TO-18	9
S9055-01	2 (VR=2 V)	фО.1	0.00	0.23	0.5 (VR=2 V)		

### Spectral response

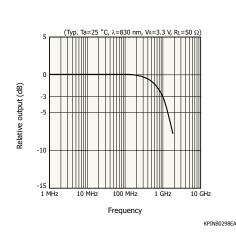


Terminal capacitance vs. reverse voltage

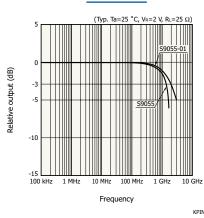


Frequency response

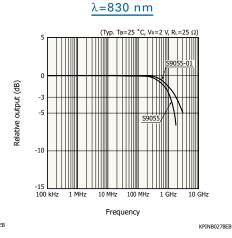
[ S5973, S5973-01 ]



λ=410 nm



[ S9055 series ]





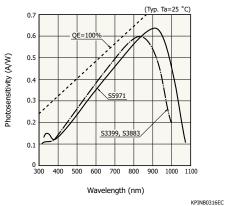
## Cutoff frequency: 100 MHz to less than 1 GHz

These Si PIN photodiodes have a large photosensitive area (\$\phi 0.8 to \$\phi 3\$ mm) yet deliver excellent frequency response characteristics. (Typ. Ta=25 °C)

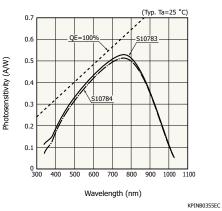
							(Typ. 14=25 C)
Type no.	Cutoff frequency	Photosensitive area size		nsitivity W)	Terminal capacitance f=1 MHz	Package	Photo
	(MHz)	(mm)	λ=660 nm	λ=780 nm	(pF)		
S5971	100	φ1.2	0.44	0.55	3 (VR=10 V)	TO-18	8
S3399	(VR=10 V)	ф3	0.45	0.58	20 (VR=10 V)	TO-5	
S3883	300 (VR=20 V)	φ1.5	0.45	0.56	6 (VR=20 V)	10 0	
S10783	300	ф0.8	0.46	0.52	4.5 (VR=2.5 V)	Plastic	es en en
S10784	(VR=2.5 V)	ф3	0.45	0.51		Plastic with lens	
S5972	500 (VR=10 V)	ф0.8	0.44	0.55	3 (VR=10 V)	TO-18	8

#### Spectral response

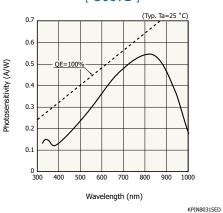




#### [ S10783, S10784 ]

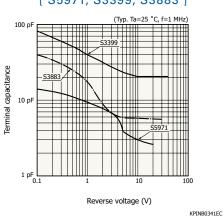


#### [S5972]

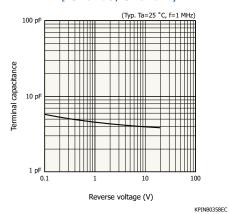


#### Terminal capacitance vs. reverse voltage

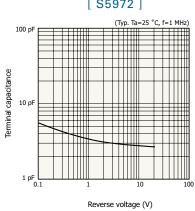
#### [ S5971, S3399, S3883 ]



#### [ S10783, S10784 ]



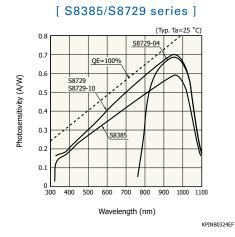
#### [S5972]

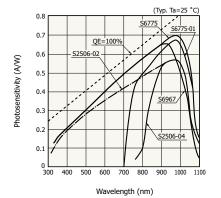


## Cutoff frequency: 10 MHz to less than 100 MHz

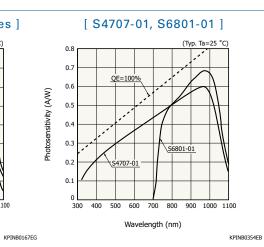
Type no.	Cutoff frequency	Photosensitive area size	Photose (A/	nsitivity W)	Terminal capacitance f=1 MHz	Package	Photo
Type no.	(MHz)	(mm)	λ=660 nm	λ=780 nm	(pF)	i ackage	1 11010
S6775	15 (VR=10 V)		0.45	0.55	40 (VR=10 V)		
S6967	50 (VR=10 V)	5.5 × 4.8	0.40	0.55	50 (VR=10 V)		
S6775-01	15 (VR=10 V)		0.54 (λ=830 nm)	0.68 (λ=λp)	40 (VR=10 V)		
S8385		2 × 2	0.4	0.48	12 (VR=5 V)		
S8729	25		0.45	0.55			
S8729-04	(VR=5 V)	=5 V) 2 × 3.3	0.52 (λ=830 nm)	0.68 (λ=λp)	16 (VR=5 V)	Plastic	7
S8729-10			0.45	0.55			
S2506-02	25	25	0.4	0.48	15		
S2506-04	(VR=12 V)	2.77 × 2.77	0.25 (λ=830 nm)	0.56 (λ=λp)	(VR=12 V)		
S4707-01	20 (VR=10 V)	2.4 × 2.8	0.4	0.48	14 (VR=10 V)		
S6801-01	15 (VR=10 V)	φ14 (lens diameter)	0.52 (λ=830 nm)	0.65 (λ=λp)	50 (VR=10 V)	Plastic with \$p\$14 mm lens	

#### Spectral response





[ S6775/S6967/S2506 series ]

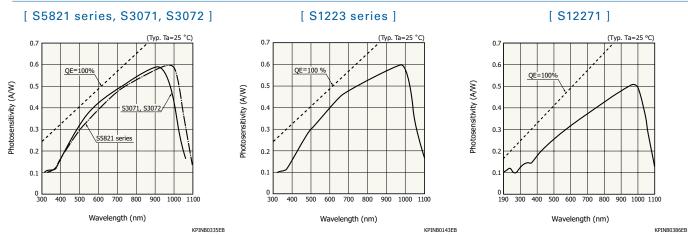


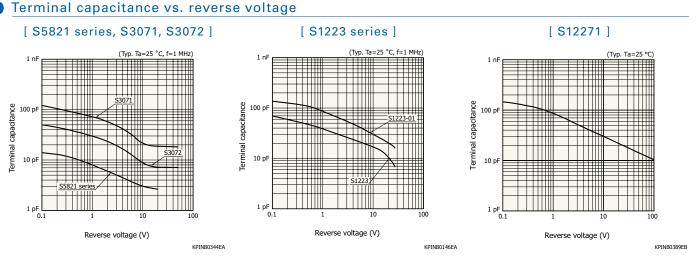
(Typ. Ta=25 °C)

Type no.	Cutoff frequency	Photosensitive area size		nsitivity W)	Terminal capacitance f=1 MHz	Package	Photo
	(MHz)	(mm)	λ=660 nm	λ=780 nm	(pF)		
S5821		φ1.2					
S5821-02	25	Ψ1.2	0.45	0.52	3	TO-18	
S5821-01	(VR=10 V)	(VR=10 V) \$\phi 4.65\$ (lens diameter)			(VR=10 V)		A
S5821-03							
S1223	30 (VR=20 V)	2.4 × 2.8	0.45	0.52	10 (VR=20 V)		9
S1223-01	20 (VR=20 V)	3.6 × 3.6	0.45	0.52	20 (VR=20 V)	TO-5	
S3072	45 (VR=24 V)	ф3	0.47	0.54	7 (VR=24 V)		
S3071	40 (VR=24 V)	φ5	0.47	0.54	18 (VR=24 V)	TO 0	9
S12271*	60 (VR=100 V)	φ4.1	0 (λ=96	.5 0 nm)	10 (VR=100 V)	TO-8	

<sup>\*</sup> Refer to "Precautions against UV light exposure" (P.45).

### Spectral response





## Multi-element type Si photodiodes

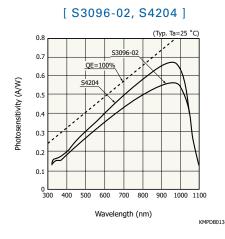
## Segmented type Si PIN photodiodes

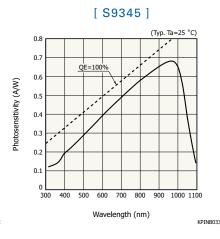
These Si PIN photodiode arrays consist of 2 or 4 elements having sensitivity in the UV to near IR range.

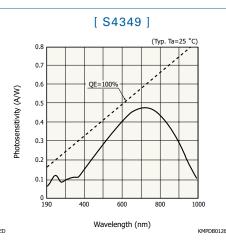
(Typ. Ta=25 °C)

Type no.	Number of elements	Photosensitive area size (mm)		Photosensitivity (A/W)	Cutoff frequency VR=10 V RL=50 Ω (MHz)	Dark current VR=10 V max. (nA)	VR= f=1	apacitance 10 V MHz F)	Package	Photo
S3096-02		1.2 × 3 /2-seg- ment	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	0.39 (λ=650 nm)	25	0.5* <sup>1</sup>	į	ō		
S4204	2	1 × 2 /2-seg- ment	0.5	0.45 (λ=650 nm)	30	1* <sup>1</sup>	;	3	Plastic	
S9345		1.5 × 1.5 + 1.5 × 4.1	B 1.4	0.45 (λ=650 nm)	15	5* <sup>1</sup>	4 / Photo- /diode A	10 (Photo- (diode B)		
S4349* <sup>2</sup>	4	3 × 3 /4-seg- ment	0.1	0.45 (λ=720 nm)	20 (VR=5 V)	0.2 (VR=5 V)		5 =5 V)	TO-5	

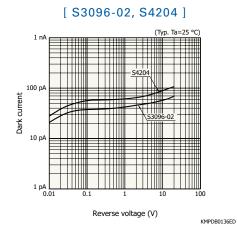
## Spectral response

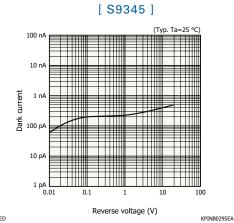


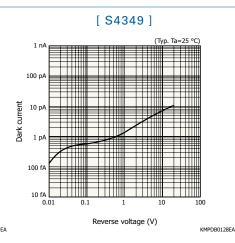




#### Dark current vs. reverse voltage







<sup>\*1:</sup> Total number of elements \*2: Refer to "Precautions against UV light exposure" (P.45).



## One-dimensional photodiode arrays (UV to near IR: UV sensitivity enhanced type)

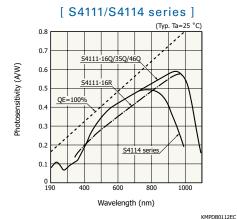
These are Si photodiode linear arrays having rectangular elements equally spaced at a pitch of about 1 mm.

(Typ. Ta=25 °C)

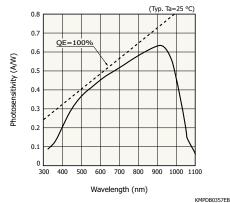
Type no.	Number of elements	Element pitch (mm)	Element size W × H (mm)	Spectral response range (nm)	Photosensitivity λ=960 nm (A/W)	Dark current VR=10 mV max.	Terminal capacitance VR=0 V f=10 kHz	Package	Photo
S4111-16Q* <sup>2</sup>		(111111)	(111111)	190 to 1100	(A/VV)	(pA)	(pF)		
	16		$0.9 \times 1.45$		_	5	200		A A A A A A A
S4111-16R				340 to 1100					
S4111-35Q* <sup>2</sup>	35			190 to 1100	0.58	10	550		
S4111-46Q*2	46	1.0	0.9 × 4.4	130 to 1100		10	330	Ceramic	1
S4114-35Q*2	35		0.9 × 4.4	190 to 1000	0.50	60	35		::
S4114-46Q*2	46			100 to 1000	(λ=800 nm)	00	33		1
S12858-021		1.17	0.77 × 2.5			30	30		
S12859-021		1.17	0.77 x 2.5			30	30		
S11299-021	16	1.575	1 175 × 2 0	340 to 1100	0.61	30	40	Glass epoxy (unsealed)	
S11212-021		1.575	1.175 X 2.0	340 10 1100	(λ=920 nm)	30	40		GULLED
S12362-021		2.5	2.2 × 2.7			EO	75		
S12363-021		2.5	2.2 × 2.7			50	/5		2222222

<sup>\*2:</sup> Refer to "Precautions against UV light exposure" (P.45).

## Spectral response

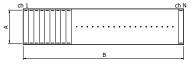


#### [ \$12858/\$12859/\$12362/\$12363/\$11212/\$11299-021 ]



#### Structure of photosensitive area (unit: mm)

#### [ S4111/S4114 series ]



Type no.	Α	В	N
S4111-16R/-16Q	1.45	15.9	16
S4111/S4114-35Q	4.4	34.9	35
S4111/S4114-46Q	4.4	45.9	46

#### [ S11212/S11299-021 ]



KMPDA0228EC

## Surface mount type Si photodiodes

## High-speed response Si PIN photodiodes

These are photodiodes sealed in a chip carrier package suitable for surface mounting and allowed solder reflow mounting on PC boards for automated processes.

(Typ. Ta=25 °C)

Type no.	Cutoff frequency VR=10 V (MHz)	Photosensitive area size (mm)	Spectral response range (nm)	Photosensitivity λ=960 nm (A/W)	Terminal capacitance VR=10 V f=1 MHz (pF)	Package	Photo	
S5106	20	5 × 5			40			
S5107	10	10 × 10	320 to 1100	0.72	150	Ceramic		
S7509	20	2 × 10	320 to 1100	320 to 1100	0.72	40	Ceramic	
S7510	15	6 × 11			80			

## Segmented type Si photodiodes

These Si photodiodes consist of 2, 4 or 16 elements and are integrated into a chip carrier package.

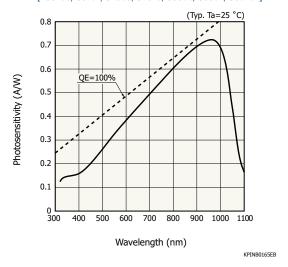
(Typ. Ta=25 °C)

Type no.	Number of elements	Photosensitive area size (mm)		Spectral response range (nm)	Photosensitivity λ=960 nm (A/W)	Cutoff frequency VR=10 V (MHz)	Terminal capacitance VR=10 V f=1 MHz (pF)	Package	Photo
S5980	4	5 × 5 /4-seg- ment	0.03			25	10		
S5981	4	10 × 10 /4-seg- ment	0.03	320 to 1100	0.72	20	35	Ceramic	
S5870	2	10 × 10 /2-seg- ment	0.03	320 (0 1100	0.72	10	50	Ceramic	
S8558	- 16	2 × 12.7 /16-seg-	ch1 ch16			25	5		
NEW S15158	10	ment	0.1	380 to 1100	0.63	25	60 (Total of all elements)	Glass epoxy	

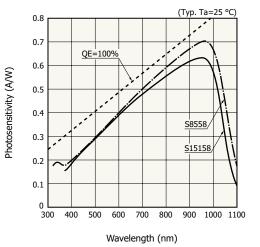


#### Spectral response

#### [ \$5106, \$5107, \$7509, \$7510, \$5980, \$5981, \$5870 ]



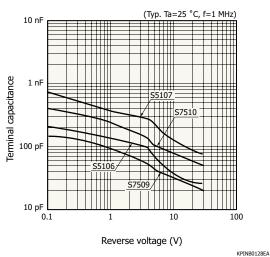
#### [ S8558, S15158 ]



#### KMPDB0193EC

## Terminal capacitance vs. reverse voltage

#### [ S5106, S5107, S7509, S7510 ]



#### Small package type Si photodiodes

These surface mount type Si photodiodes are mounted on small packages. They are tape packaged and allows solder reflow mounting.

Type no.	Photosensitive area size (nm)	Spectral response range (nm)	Photosensitivity λ=960 nm (nm)	Terminal capacitance VR=0 V f=10 kHz (pF)	Package	Photo
S9674	2 × 2		0.7	500		
NEW S9981-01CT	1.3 × 1.3	320 to 1100	0.65	200	Glass epoxy	
S10625-01CT	1.3 X 1.3		0.54 (λ=940 nm)	200		

#### Small package type Si PIN photodiodes

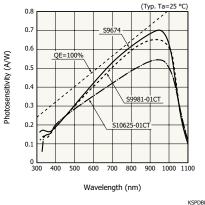
These surface mount type Si PIN photodiodes are mounted on small packages. They are tape packaged and allows solder reflow mounting.

(Typ. Ta=25 °C)

Type no.	Photosensitive area size (mm)	Spectral response range (nm)	Photosensitivity λ=960 nm (A/W)	Terminal capacitance f=1 MHz (pF)	Package	Photo
S13773	*O O	290 to 1000	0.54 (λ=800 nm)	3 (VR=10 V)		
NEW S15193	φ0.8	380 to 1000	0.64 (λ=920 nm)	2 (VR=10 V)		a
S10993-02CT	1.06 × 1.06	380 to 1100	0.6	6 (VR=2.5 V)	Glass epoxy	
S12158-01CT	2.77 × 2.77	320 to 1100	0.7	15 (VR=12 V)		
NEW S13954-01CT	φ1.5	320 to 1000	0.5 (λ=780 nm)	13 (VR=3 V)		10.
NEW S14016-01DT	2.1 × 1.8	320 to 1100	0.7	12 (VR=5 V)	Plastic	

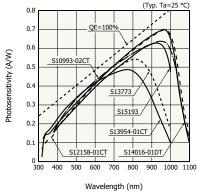
#### Spectral response

#### [ S9674, S9981-01CT, S10625-01CT ]



KSPDB0315EC

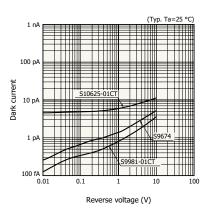
#### [ \$13773, \$15193, \$10993-02CT, \$12158-01CT \$13954-01CT, \$14016-01DT ]



KSPDB0318ED

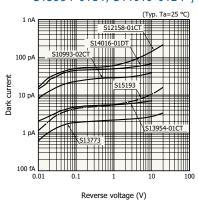
#### Dark current vs. reverse voltage

#### [ S9674, S9981-01CT, S10625-01CT ]



KSPDB0316EF

#### [ \$13773, \$15193, \$10993-02CT, \$12158-01CT \$13954-01CT, \$14016-01DT ]



KSPDB0393EA

## Si photodiodes with preamp, TE-cooled type Si photodiodes

#### Si photodiodes with preamp for measurement

These are low noise photosensors incorporating a large area Si photodiode, op amp and feedback capacitance.

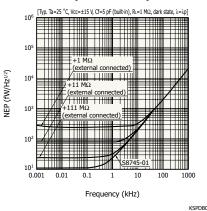
(Typ. Ta=25 °C)

Type no.	$\begin{array}{c} \text{Cooling} \\ \text{temperature} \\ \Delta \text{T} \end{array}$	Photosensitive area size	Spectral response range	Photose (V/r	nsitivity nW)	NEP λ=λp, f=10 Hz	Built-in feedback resistance	Package	Photo
	(°C)	(mm)	(nm)	λ=200 nm	λ=960 nm	(fW/Hz <sup>1/2</sup> )	(GΩ)		
S8745-01*	Non-cooled	2.4 × 2.4		0.12	0.52	11	1		
S8746-01*	TNOIT-COOIEG	5.8 × 5.8	190 to 1100		0.52	15	ı	Metal	
S9295*	50	10 × 10	190 to 1100		5.1	4	10	Metal	
S9295-01*	30	10 × 10		0.9	5.1	5	10		

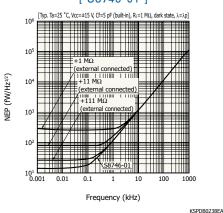
<sup>\*</sup> Refer to "Precautions against UV light exposure" (P.45).

## NEP (noise equivalent power) vs. frequency

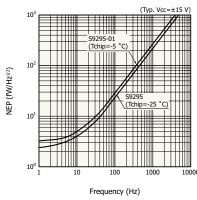
#### S8745-01



#### [ S8746-01 ]



#### [ S9295 series ]



KSPDB0230EC

## TE-cooled type Si photodiodes

These photosensors combine a UV to near infrared Si photodiode with a TE-cooler and deliver low dark current.

(Typ. Ta=25 °C)

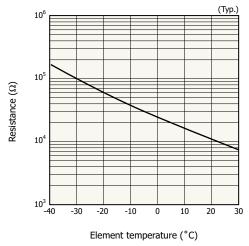
Type no.	Cooling temperature $\Delta T$ (°C)	Photosensitive area size (mm)	Spectral response range (nm)	Peak sensitivity wavelength (nm)	Dark current VR=10 mV (pA)	NEP (W/Hz <sup>1/2</sup> )	Package	Photo
S2592-03*		2.4 × 2.4			10	8.1 × 10 <sup>-15</sup>	TO-8	
S2592-04*	35	5.8 × 5.8	190 to 1100	960	25	$1.3 \times 10^{-14}$	10-6	
S3477-03*	35	2.4 × 2.4	190 10 1100	960	10	8.1 × 10 <sup>-15</sup>	TO-66	
S3477-04*		5.8 × 5.8			25	1.3 × 10 <sup>-14</sup>	10-66	THE

<sup>\*</sup> Refer to "Precautions against UV light exposure" (P.45).

### Spectral response

## 0.7 0.6 0.5 0.4 0.2 0.1 190 300 400 500 600 700 800 900 1000 1100 Wavelength (nm)

### Thermistor temperature characteristics



## Si photodiodes for X-ray detection

## Si photodiodes with scintillator

These detectors are comprised of a Si photodiode coupled to a scintillator. Ceramic scintillators have sensitivity to X-rays about 1.2 times higher than CWO and offer high reliability. Csl scintillators also have high sensitivity and are low-cost.

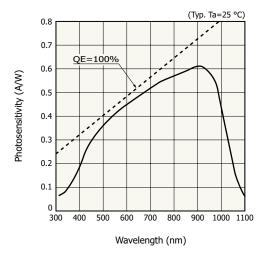
The S11212 and S11299 series photodiode arrays have a back-illuminated structure. They realize superb spectral response and sensitivity uniformity compared to our previous products.

(Typ. Ta=25 °C)

Type no.	Scintillator	Number of elements	Element pitch (mm)	Element size W × H (mm)	Dark current max. VR=10 mV (pA)	X-ray sensitivity* (nA)	Package	Photo			
S8559	CsI(TI)	1	_	5.8 × 5.8	50	52	Ceramic				
S8193	GOS ceramic	ı	-	5.6 × 5.6	50	30	Ceramic				
S12858-122	- CsI(TI)					5.0		-			
S12859-122	CSI(TI)					5.0					
S12858-324	000	10	4.47	0.77 0.5	00	0. [					
S12859-324	GOS ceramic	16	1.17	0.77 × 2.5	30	2.5	Glass epoxy				
S12858-422	Phosphor										
S12859-422	sheet					2.2					
S11299-121	O LITI					0.0		COLUMN TO SERVICE STATE OF THE			
S11212-121	- CsI(TI)					6.0		KARATA AND AND AND AND AND AND AND AND AND AN			
S11299-321	000	10	4 5 7 5	4.475		0.5		Daniel Committee			
S11212-321	GOS ceramic	16	1.575	1.175 × 2.0	30	3.5	Glass epoxy	PRESERVE AND ADDRESS OF THE PERSON ADDRESS OF THE PERSON AND ADDRESS OF THE PERSON ADDRESS OF THE PERSON ADDRESS OF THE PERSON AND ADDRESS OF THE PE			
S11299-422	Phosphor					2.0		CHARGE CO.			
S11212-422	sheet					3.0		S			
S12362-121	0.1/TI)					40.5					
S12363-121	- CsI(TI)					12.5		*********			
S12362-321											
S12363-321	GOS ceramic	16	2.5	2.2 × 2.7	50	7.2		- CONTRACTOR - CON			
S12362-421	Phosphor										
S12363-421	Phosphor sheet	Phosphor sheet	Phosphor sheet	Phosphor sheet					6.0		Brandan

<sup>\*</sup> These are for reference (X-ray tube voltage: 120 kV, tube current: 1.0 mA, aluminum filter t=6 mm, distance: 830 mm), X-ray sensitivity depends on the X-ray equipment operating and setup conditions.

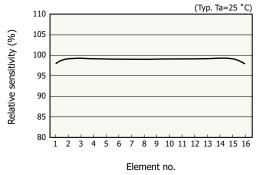
#### Spectral response (S12858/S12859/S11212/S11299/S12362/S12363 series)



<sup>\*</sup> The characteristics exclude the scintillator but include the transmittance and reflectance of the adhesive resin used to bond a scintillator.

KMPDB0360ED

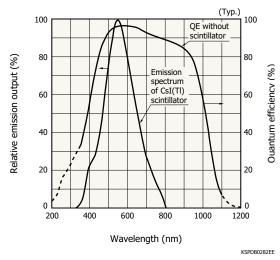
## Uniformity (S11212/S11299 series)



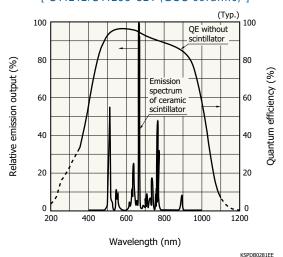
KMPDB0361EC

## Emission spectrum of scintillator and spectral response

#### [ S11212/S11299-121 [CsI(TI)] ]



#### [ S11212/S11299-321 (GOS ceramic) ]



#### ▲ Typical scintillator characteristics

Parameter	Condition	CsI(TI)	GOS ceramic	Unit
Peak emission wavelength		560	512	nm
X-ray absorption coefficient	100 keV	10	7	cm <sup>-1</sup>
Refractive index	λ=λρ	1.7	2.2	-
Decay constant		1	3	μs
Afterglow	100 ms after X-ray turn off	0.3	0.01	%
Density		4.51	7.34	g/cm <sup>3</sup>
Color		Transparent	Light yellow-green	-
Sensitivity nonuniformity		±10	±5	%



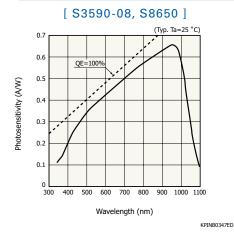
#### Large area Si PIN photodiodes

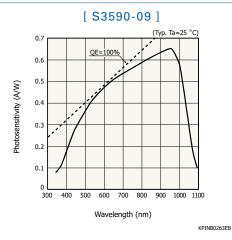
These Si PIN photodiodes, mounted on a white ceramic base, are specifically developed for applications in high energy physics and are mainly used being coupled to a scintillator. Because of high resistance to high voltages, these Si PIN photodiodes operate at high reverse voltages allowing a high-speed response despite the large photosensitive areas.

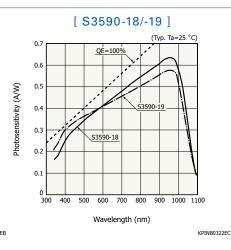
The S3590-18/-19 are violet sensitivity enhanced type and the S3590-19 is an unsealed type. To improve photodiode-to-scintillator coupling efficiency, we also offer the S8650 with epoxy resin coating window processed to have a flat surface. (Typ. Ta=25 °C)

Type no.	Window	Photosensitive area size (mm)	Depletion layer thickness VR=70 V (mm)	Spectral response range (nm)	Photosensitivity λ=960 nm (A/W)	Dark current max. VR=70 V (nA)	Terminal capacitance VR=70 V f=1 MHz (pF)	Package	Photo
S3590-08	Epoxy resin				0.66	6			
S3590-09	Unsealed				0.66	0			
S3590-18	Epoxy resin	10 × 10	0.3	340 to 1100	0.65	10	40	Ceramic	
S3590-19	Unsealed		0.0		0.58	10		00.00	
S8650	Epoxy resin				0.66	6			

## Spectral response



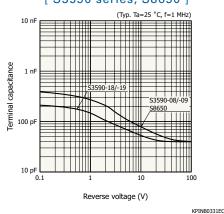


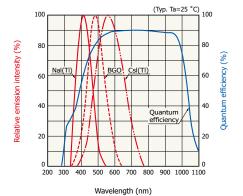


Emission spectrum of scintillators and spectral response (\$3590-08)

#### Terminal capacitance vs. reverse voltage





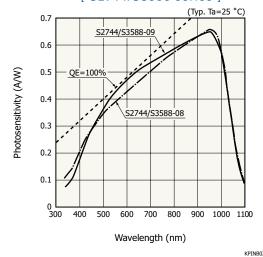


KPINB0017EE

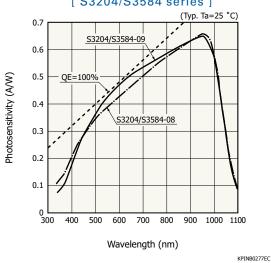
Type no.	Window	Photosensitive area size (mm)	Depletion layer thickness VR=70 V (mm)	Spectral response range (nm)	Photosensitivity \(\lambda=960\) nm \((A/W)\)	Dark current max. VR=70 V (nA)	Terminal capacitance VR=70 V f=1 MHz (pF)	Package	Photo
S2744-08	Epoxy resin					10	85		
S2744-09	Unsealed	18 × 18 28 × 28		340 to 1100	0.66	10	65	Ceramic	
S3204-08	Epoxy resin		0.3 340 to 1100			20	130		
S3204-09	Unsealed								
S3584-08	Epoxy resin				0.66	30	300		
S3584-09	Unsealed				30	300			
S3588-08	Epoxy resin					10	40		
S3588-09	Unsealed	3 × 30				10	40		

#### Spectral response

#### [ S2744/S3588 series ]

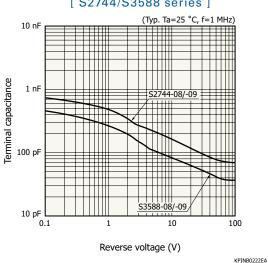


#### [ S3204/S3584 series ]

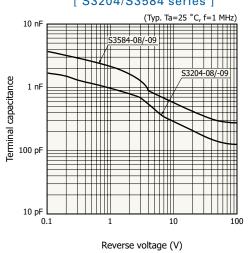


### Terminal capacitance vs. reverse voltage

#### [ S2744/S3588 series ]



#### [ S3204/S3584 series ]



KPINB0230EC



## Large area type Si PIN photodiodes for direct radiation detection

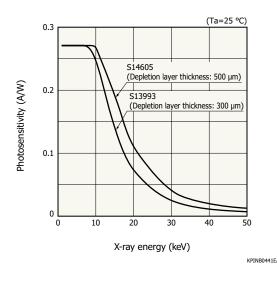
These are unsealed type large area Si PIN photodiodes for direct radiation detection. High energy radiation can be detected with high efficiency.

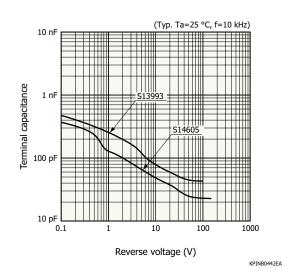
(Typ. Ta=25 °C)

Type no.	Window	Photosensitive area size (mm)	Depletion layer thickness (mm)	X-ray energy max. (keV)	Dark current max. (nA)	Package	Photo
NEW S13993	None	10 × 10	0.3	50	6	- Ceramic	
NEW S14605		9 × 9	0.5	50	30		

## Photosensitivity vs. X-ray energy (theoretical value)







## Special application Si photodiodes

#### RGB color sensors

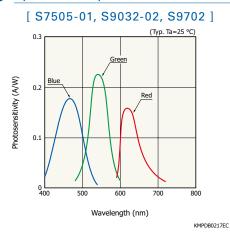
These photosensors are color sensors using a 3-element photodiode with color sensitivity, assembled in one package.

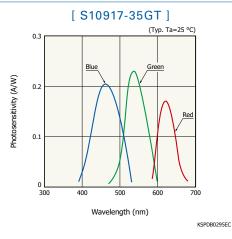
(Typ. Ta=25 °C)

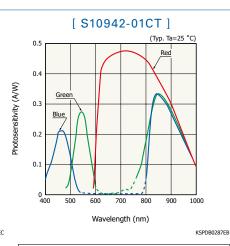
										(Typ. Ta=25 C)
Type no.	Spectral response range		$\begin{array}{c} \text{Peak} \\ \text{sensitivity} \\ \text{wavelength} \end{array}  \begin{array}{c} \text{Photosensitivity} \\ \lambda = \lambda p \end{array}$			Dark current VR=1 V Total number of elements max.	Photosensitive area size		Package	Photo
		(nm)	(nm)	(A/W)		(pA)	(mm)			
	Blue	400 to 540	460	Blue	0.18		Blue	1.5 × 1.5 (× 2)	Surface mount type plastic	
S7505-01	Green	480 to 600	540	Green	0.23	200	Green	1.5 × 1.5		
	Red	590 to 720	620	Red	0.16		Red	1.5 × 1.5		
	Blue	400 to 540	460	Blue	0.18		φ2 / 3-segment		Surface mount type plastic	
S9032-02*1	Green	480 to 600	540	Green	0.23	100				
	Red	590 to 720	620	Red	0.16					
	Blue	400 to 540	460	Blue	0.18		1 × 1 / 3-segment		Surface mount type, small plastic	
S9702*1	Green	480 to 600	540	Green	0.23	50				
	Red	590 to 720	620	Red	0.16					
	Blue	390 to 530	460	Blue	0.2		1 × 1 / 3-segment		Surface mount type, small, glass epoxy	E Property Management of the Control
S10917-35GT	Green	470 to 600	540	Green	0.23	50				
	Red	590 to 680	620	Red	0.17					
S10942-01CT		See the spectral response.			0.21*2		1 × 1 / 3-segment		Surface mount type, small	
	See				0.25*2	50				
					0.45*2				glass epoxy	

<sup>\*1:</sup> If excessive vibration is continuously applied to the glass filter, there is a risk that the filter may come off, so secure the glass filter with a holder.
\*2: Blue: λ=460 nm, Green: λ=540 nm, Red: λ=640 nm

#### Spectral response







This sensor also has sensitivity in the infrared region, so cut off infrared light as needed.

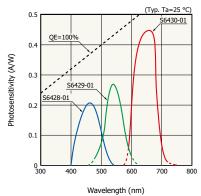


The S6428-01, S6429-01 and S6430-01 are monochromatic color sensors sensitive to blue, green and red light, respectively.

(Typ. Ta=25 °C)

Type no.	Spectral response range (nm)	Peak sensitivity wavelength (nm)	Photosensitivity λ=λp (A/W)	Dark current VR=1 V max. (pA)	Photosensitive area size (mm)	Package	Photo
S6428-01	400 to 540	460	0.22				
S6429-01	480 to 600	540	0.27	20	2.4 × 2.8	Plastic	
S6430-01	590 to 720	660	0.45				

## Spectral response



KSPDB0280E0

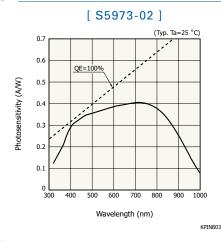
#### Violet/blue sensitivity enhanced type

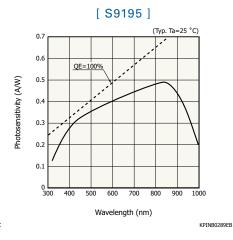
These are photodiodes for violet/blue laser diode detection.

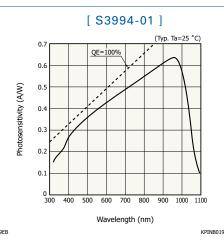
(Typ. Ta=25 °C)

Type no.	Cutoff frequency (MHz)	Photosensitive area size (mm)	Peak sensitivity wavelength (nm)	Photo- sensitivity (A/W)	Dark current max. (nA)	Terminal capacitance f=1 MHz (pF)	Package	Photo
S5973-02	1 GHz (VR=3.3 V)	ф0.4	760	0.3 (λ=410 nm)	0.1 (VR=3.3 V)	1.6 (VR=3.3 V)	TO-18	
S9195	50 (VR=10 V)	5 × 5	840	0.28 (λ=405 nm)	5 (VR=10 V)	60 (VR=10 V)	TO-8	
S3994-01	20 (VR=30 V)	10 × 10	960	0.25 (λ=400 nm)	10 (VR=30 V)	40 (VR=30 V)	Ceramic	

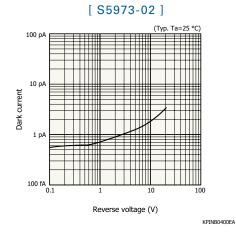
#### Spectral response

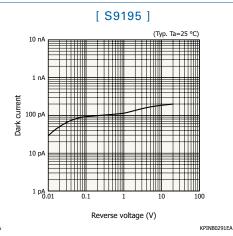


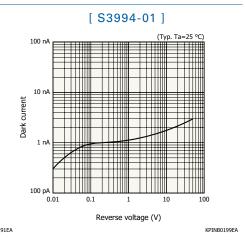




#### Dark current vs. reverse voltage









# For VUV (vacuum ultraviolet) monitor

These Si photodiodes are specially optimized for excimer laser monitor (ArF: 193 nm, KrF: 248 nm): sensitive in the vacuum UV (VUV) range.

(Typ. Ta=25 °C)

Type no.	Photosensitivity λ=193 nm (A/W)	Dark current VR=10 mV max. (nA)	Photosensitive area size (mm)	Package	Photo
S8552*	0.06	1.0	10 × 10	Ceramic (unsealed)	
S8553*	0.06	5.0	18 × 18		

<sup>\*</sup> Refer to "Precautions against UV light exposure ①" (P.45).

# For VUV detection (high reliability type)

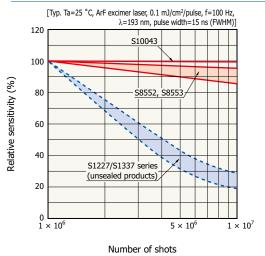
The S10043 is greatly improved in sensitivity stability even after exposure to ArF ( $\lambda$ =193 nm) excimer laser.

(Typ. Ta=25 °C)

Type no.	Photosensitivity λ=193 nm (A/W)	Dark current VR=10 mV max. (nA)	Photosensitive area size (mm)	Package	Photo
S10043*	0.015	1.0	10 × 10	Ceramic (unsealed)	

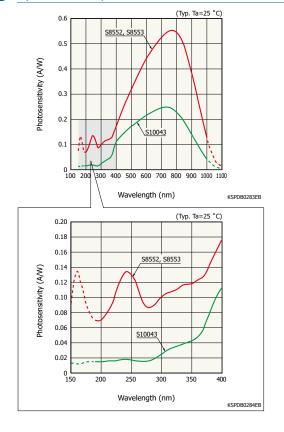
<sup>\*</sup> Refer to "Precautions against UV light exposure ①" (P.45).

# Variation in sensitivity due to UV exposure



KSPDB0264ED

# Spectral response



# For monochromatic light detection

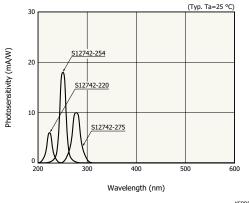
This photosensor uses an interference filter and has high sensitivity only to monochromatic light.

(Typ. Ta=25 °C)

Type no.	Peak sensitivity wavelength (nm)	Spectral response half-width (nm)	Photosensitivity \( \lambda = Center \) \( wavelength \) \( (mA/W) \)	Dark current VR=10 mV max. (pA)	Photosensitive area size (mm)	Package	Photo
S12742-220*1	220		6				
S12742-254* <sup>1</sup>	254	10	18	25	3.61 × 3.61	TO-5	8
S12742-275* <sup>1</sup>	275		10				

<sup>\*1:</sup> Refer to "Precautions against UV light exposure" (P.45).

# Spectral response



KSPDB0390EA

Note: The photosensor can be customized to support other wavelength types, including center wavelengths of 340 nm and 560 nm. (made-to-order product).

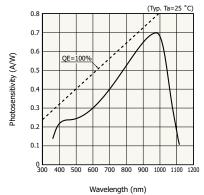
# For YAG laser detection

This is a Si PIN photodiode developed to measure infrared energy emitted from YAG lasers (1.06 µm).

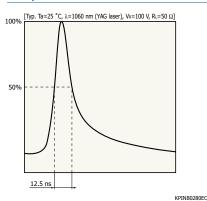
(Typ. Ta=25 °C)

Type no.	Photosensitive area size (mm)	Spectral response range (nm)		Photosensitivity λ=1060 nm (A/W)	V II - 100 V	Rise time $\lambda=1060~\text{nm}$ VR=100 V, RL=50 $\Omega$ (ns)	Package	Photo
S3759	φ5	360 to 1120	980	0.38	10	12.5	TO-8	

# Spectral response



# Response waveform



KPINB0279EB



# For electron beam detector

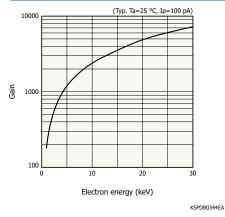
These photodiodes directly detect low energy (1 keV or more) electron beams with high sensitivity. The structure with an extremely thin dead layer (insensitive layer) makes these photodiodes ideal for backscattered electron detector for Scanning Electron Microscope (SEM).

(Typ. Ta=25°C)

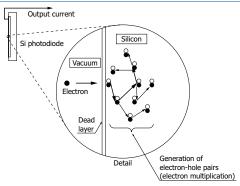
Type no.	Incident electron energy range (keV)	Output current (nA)	Dark current VR=5 V max. (nA)	Terminal capacitance VR=5 V (pF)	Cutoff frequency VR=5 V (MHz)	Electron multiplying gain	Package	Photo
S11141-10	1 to 30	30  Electron energy:\	60 -	450	2.5	300 / Electron \	Thin	•
S11142-10	1 10 30	1.5 keV  p*2=100 pA		200	5	energy: 1.5 keV	(unsealed)	

<sup>\*2:</sup> Probe current

# Gain vs. electron energy



# Electron multiplication principle



Electrons generate ions as they pass through silicon. This ionization process generates a large number of electron-hole pairs that then multiply the number of electrons. The electron multiplication can boost the output current by approximately 300 times at an input electron energy of 1.5 keV (refer to "Gain vs. electron energy").

#### KSPDC0089EA

# PWB package with leads type

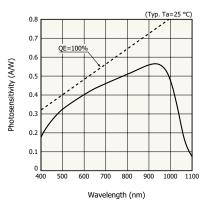
The S12497 and S12498 are Si photodiodes suitable for non-destructive inspection of baggage and the like and general industrial measurement. As they are back-illuminated photodiodes, photosensitive area does not have wires, and therefore a scintillator can be mounted directly on the photodiode.

(Typ. Ta=25 °C)

Type no.	Photosensitive area (mm)	Spectral response range (nm)	Peak sensitivity wavelength (nm)	Photo- sensitivity λ=920 nm (A/W)	Short circuit current 100 <i>Ix</i> , 2856 K (µA)	Terminal capacitance VR=0 V, f=10 kHz (pF)	Photo
S12497	9.5 × 9.5	400 to 1100	920	0.57	75	950	
S12498	6 × 6	400 10 1100			30	380	

# Spectral response

### [ S12497, S12498 ]



KSPDB0360EC

# CSP type

These are back-illuminated photodiodes employing a CSP (chip size package) that allows direct coupling of a scintillator on the chip. It is designed with minimal dead space around the product. This makes it possible to arrange multiple products side by side.

(Typ. Ta=25 °C)

Type no.	Photosensitive area size (mm)	Spectral response range (nm)	Peak sensitivity wavelength (nm)	Photo- sensitivity λ=920 nm (A/W)	Short circuit current 100 Ix, 2856 K (µA)	Terminal capacitance VR=0 V, f=10 kHz (pF)	Package	Photo
S13955-01	7.37 × 7.37				46	500		
S13956-01	2.5 × 2.5	400 to 1100	960	0.61	5.5	60	PWB (unsealed)	•
S13957-01	4.5 × 4.5				22	230		

# CSP type 64-element Si photodiode array

This is an  $8 \times 8$  element Si photodiode array with a back-illuminated type structure for X-ray non-destructive inspection. A scintillator can be directly coupled on the chip. It is designed with minimal dead space around the product. This makes it possible to arrange multiple products side by side. Moreover, there is no crosstalk between channels.

(Typ. Ta=25 °C)

Type no.	Number of elements	Element pitch (mm)	Element size W × H (mm)	Spectral response range (nm)	Peak sensitivity wavelength (nm)	Photo- sensitivity λ=920 nm (A/W)	Short circuit current 100 lx, 2856 K (µA)	Terminal capacitance VR=0 V, f=10 kHz (pF)	Package	Photo
S13620-02	64 (8 × 8)	3.0	2.5 × 2.5	400 to 1100	960	0.61	5.5	60	PWB (unsealed)	

# 6-element array for encoder

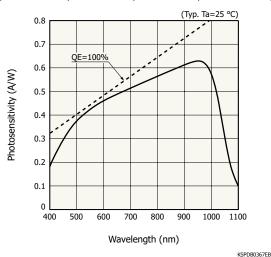
This is a surface mount type 6-element Si PIN photodiode. The six elements are separated individually and arranged so that they are suitable for the incremental encoder.

(Typ. Ta=25 °C)

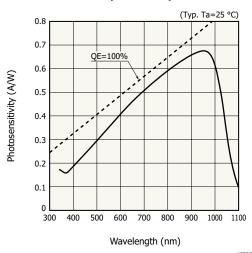
Type no.	Number of elements	Element size W × H (mm)	Spectral response range (nm)	Peak sensitivity wavelength (nm)	Photo- sensitivity λ=960 nm (A/W)	Terminal capacitance VR=10 V, f=10 kHz (pF)	Package	Photo
NEW S14833	6	2.76 × 1.37	340 to 1100	960	0.68	9	Glass epoxy	基

# Spectral response

#### [ \$13955-01, \$13956-01, \$13957-01, \$13620-02 ]



# [ S14833 ]



KSPDB0570EA

# Related products of Si photodiode

#### RGB color sensor modules

#### For TFT-LCD monitor

RGB-LED backlight monitor for TFT-LCD (liquid crystal display)

#### Features

# ■ Built-in RGB color sensor (S9032-02) Sensitivity matches wavelengths of RGB-LED backlight for TFT-LCD.

- 3 ch current-to-voltage amplifiers Simultaneous output of 3 ch RGB photocurrent
- Configuration and size suitable for side mounting to TFT-LCD
- Low current consumption: 0.4 mA typ. (1/3 than the conventional type)
- High gain type (C9303-04)

Applications

■ RGB-LED backlight monitor for TFT-LCD



(Typ. Ta=25 °C)

Type no.		Photosensitivity (V/mW)	Cutoff frequency -3 dB	Supply voltage	
	λp=620 nm	λp=540 nm	λp=460 nm	(kHz)	(V)
C9303-03	-14	-20	-18	16	+2.7 to +5.5
C9303-04	-108	-156	-122	2.4	+2.7 (0 +5.5

# Simple color measurement

Numerically converts RGB color information and outputs data for PCs

#### Features

- Measures object color information as a reflective type\*
- Measures small areas using an objective optical fiber
- 12-bit digital output
- Serial connection (RS-232C) with PC
- Teaching function
- Sample software included

#### **Applications**

- Color monitoring and simple detection of color difference of opaque body (painting, printing, cosmetics, etc.)
- Teaching material for simple color measurements



(Typ. Ta=25 °C)

Type no.	Light source	Photosensor	Measurement and output cycle (ms)	Supply voltage (V)
C9315	White LED	Si photodiode	200	AC adapter (+12)

<sup>\*</sup> Does not conform to CIE (International Commission on Illumination) standards

#### Color sensor evaluation circuit

Color sensor evaluation circuit board

#### Features

- 3 ch current-to-voltage conversion amplifier for color sensor evaluation
- Color sensors that mount on C9331: S7505-01, S9032-02 (sold separately)

#### Applications

■ Evaluation of Hamamatsu color sensor



(Ta=25 °C, Vcc=9.0 V, common to each RGB channel)

Type no.	Output offset voltage Zt=5.1 × 10 <sup>5</sup> V/A [without photodiode] (mV)		Conversion impedance	Cutoff frequency [without photodiode] -3 dB	Supply voltage
	Тур.	Max.	(V/A)	(kHz)	(V)
C9331	±40	±50	$1 \times 10^5 \text{ to } 5.1 \times 10^5$	14	+7 to +15

# Driver circuit for Si photodiode array

#### Driver circuit for 16-element photodiode array

#### Features

- High precision and high-speed measurement by simultaneous 16-channel readout
- Assembled with pulse generator (8-step adjustable oscillatory frequency) CLK, START, A/D conversion Trig and EOS pulse output
- Choice of gain (conversion impedance):  $1 \times 10^6$  V/A or  $1 \times 10^7$  V/A
- Accessory AC adapter (+12 V) operation



# nsor

#### Photodiode modules

#### • Integrates a Si photodiode for precision photometry with low-noise amplifier.

The C10439 series is a high-precision photodetector that combines a photodiode and current-to-voltage conversion amplifier.

#### **Features**

■ Easy handling

The output from these photodiode modules is an analog voltage and can be checked with a voltmeter, etc.

■ Two switchable photosensitivity ranges

High accuracy output can be obtained by selecting a range suitable for the light level to be detected.

■ Compact size

Half the size of a business card (C10439-15: business card size) Can be mounted directly on optical bench rod (M4).

(Typ. Ta=25 °C)

99991I

Type no.		itive area size mm)	Peak sensitivity wavelength (nm)	Photosensitivity $\lambda = \lambda p$ (mV/nW)	Conversion impedance (V/A)	Cutoff frequency -3 dB (Hz)	Supply voltage (V)	Dimensions W × D × H (mm)
C10439-01		2.4 × 2.4			H: 10 <sup>9</sup> L: 10 <sup>7</sup>		External power supply	19 × 46 × 52
C10439-02		5.8 × 5.8		H: 500 L: 5		H: 10 L: 1k		
C10439-03	Si	10 × 10	960					
C10439-07	31	2.4 × 2.4	960			H: 1k L: 100k* <sup>1</sup>		
C10439-08		5.8 × 5.8		H: 0.5 L: 0.005				
C10439-09		10 × 10		2. 0.000	H: 10 <sup>6</sup> L: 10 <sup>4</sup>			
C10439-10	InGaAs	φ1	1550	H: 1				19 × 50 × 52
C10439-11	IIIGaAS	ф3	1550	L: 0.01			±5 to ±12	
C10439-14	InAsSb	0.7 × 0.7	4100	H: 0.045* <sup>2</sup> L: 0.0045* <sup>2</sup>	H: 10 <sup>7</sup> L: 10 <sup>6</sup>	H: 100 L: 1k		
C10439-15	Si	2.4 × 2.4	940	H: 0.45 L: 0.045	H: 10 <sup>6</sup> L: 10 <sup>5</sup>	H: 10k		19 × 50 × 75
	InGaAs	ф1	2300	H: 0.6 L: 0.06		L: 100k*1		

# Signal processing unit for photodiode module

### • Unit dedicated for photodiode module (C10439 series)

The C10475 converts the output from a photodiode module (C10439 series) into digital signals. Also supplies power to the photodiode module.

#### Features

- High-resolution digital output (16-bit)
- Data logger function



(Typ. Ta=25 °C)

Type no.	Digital output	Minimum measurement time interval (ms)	Supply voltage (V)	Dimensions W × D × H (mm)
C10475	Conforms to RS-232C (16-bit)	50	AC adapter (+12) or battery (+9)	110 × 100 × 30



# Photosensor amplifier

# For low-light-level detection

 Digital output function, current-to-voltage conversion amplifier for amplifying very slight photocurrent with low noise

#### **Features**

- Three sensitivity ranges
- Selectable operation modes (analog output / digital output)
- Serial connection (RS-232C) with PC
- Data logger function, low battery function



Photodiode, coaxial cable with BNC-BNC plug and RS-232C cable are optional.

(Typ. Ta=25 °C)

Type no.	Range	Conversion impedance (V/A)	Cutoff frequency -3 dB (Hz)	Power supply (V)	Dimensions W × D × H (mm)	
C9329	Н	10 <sup>9</sup>	16		115 × 90 × 40	
	М	10 <sup>7</sup>	1600	AC adapter (+12) or battery (+9)		
	L	10 <sup>5</sup>	1600	0. 201101 7 (10)		

# With optical fiber

Light-to-voltage conversion amplifier with optical fiber

#### Features

■ Easy handling

Built-in photodiode allows easy detection of light just by connecting to a voltmeter, etc.

■ Optical fiber light input

Measures light at a narrow detection point. Separating the amplifier from the detection point allows measurement in unusual environments and achieves low noise.

■ Three sensitivity ranges

(Typ. Ta=25 °C)

Type no.	Range	Photosensitivity λ=830 nm (mV/μW)	Conversion impedance (V/A)	Cutoff frequency -3 dB (MHz)	Power supply (V)	Dimensions W × D × H (mm)
C6386-01	Н	30	10 <sup>5</sup>	1	External power	115 × 90 × 40
	М	3	10 <sup>4</sup>	3	supply (±15) or batteries	
	L	0.3	10 <sup>3</sup>	10	(+9) × 2	

# High-speed type

Current-to-voltage conversion amplifier

#### Features

- C8366: for high speed Si PIN photodiode C8366-01: for high speed InGaAs photodiode
- Wide bandwidth: DC to 100 MHz typ. (-3 dB; varied by the photodiode used)
- Just inserting the photodiode leads makes the connection. (Compatible with TO-8, TO-5 and TO-18 packages)
- Adjustable response speed

Response speed can be adjusted by a trimmer potentiometer easily.

■ Compact size

				(Typ. Ta=25 °C)	
Type no.	Conversion impedance (V/A)	Cutoff frequency -3 dB (MHz)	Power supply (V)	Dimensions W × D × H (mm)	
C8366	103	100	External necessary accordes (+ 1E)	10 52 40	
C8366-01	10 <sup>3</sup>	100	External power supply (±15)	19 × 52 × 46	



# Compact board type

• Current-to-voltage conversion amplifier for low-level-light

#### Features

- Compact board type for easy assembly
- Usable with photodiodes having large terminal capacitance
- Conversion impedance: 10<sup>8</sup> V/A



(Typ. Ta=25 °C)

Type no.	Conversion impedance (V/A)	Cutoff frequency -3 dB (Hz)	Power supply (V)	Dimensions W × D × H (mm)
C9051	10 <sup>8</sup>	16	AC adapter (+12)	50 × 50 × 19

# Charge amplifier

#### • For radiation and high energy particle detection

The H4083 is a low-noise hybrid charge amplifier designed for a wide range of spectrometric applications including soft X-ray and low to high energy gamma-ray spectrometry. The first stage of this amplifier uses a low-noise junction type FET, which exhibits excellent performance when used with a photodiode having a large junction capacitance. The H4083 is especially suited for use with Hamamatsu S3590/S3204 series, etc. Si PIN photodiodes. S3590 series photodiodes can be directly mounted on the backside of the H4083, so there will be no increase in stray capacitance.



#### Features

- Low noise
- Compact and lightweight
- Easy handling

#### Applications

■ Detection of X-rays, radiation, high energy particles

(Typ. Ta=25 °C)

Type no.	Amplification method	Input/ output polarity	Charge gain	Noise characteristic (e <sup>-</sup> /FWHM)	Negative feedback constant	Power supply (V)	Current consumption (mW)	Dimensions W × D × H (mm)
H4083	Charge-sensitive type	Inverted	0.5 V/pC 22 mV/MeV (Si)	550	50 MΩ//2 pF	±12	150	24 × 19 × 4

# Description of terms

#### Spectral response

The photocurrent produced by a given level of incident light varies with the wavelength. This relation between the photoelectric sensitivity and wavelength is referred to as the spectral response characteristic and is expressed in terms of photosensitivity or quantum efficiency.

#### Photosensitivity: S

This measure of sensitivity is the ratio of photocurrent expressed in amperes (A)—or output voltage expressed in volts (V)—to the incident light expressed in watts (W). It may be represented as either an absolute sensitivity (A/W or VW unit) or as a relative sensitivity normalized for the sensitivity at the peak wavelength, usually expressed in percent (%) with respect to the peak value. At Hamamatsu, we usually use absolute sensitivity to express photosensitivity, and the spectral response range is defined as the region in which the relative sensitivity is higher than 5% or 10% of the peak value.

#### ▶ Quantum efficiency: QE

The quantum efficiency is the number of electrons or holes that can be detected as a photocurrent, divided by the number of incident photons. This is commonly expressed in percent (%). The quantum efficiency and photo sensitivity S have the following relationship at a given wavelength (nm):

$$QE = \frac{S \times 1240}{\lambda} \times 100 \, [\%]$$

#### ▶ Short circuit current: Isc

The output current that flows through the photodiode when the load resistance is 0. This is often called "white light sensitivity" with regards to the spectral response, and a tungsten lamp of 2856 K distribution temperature (color temperature) is used for the light source. At Hamamatsu, we indicate the short circuit current at  $100\ lx$  illuminance in the table of characteristics in our catalogues.

#### Open circuit voltage: Voc

The open circuit voltage is a photovoltaic voltage generated when the load resistance is infinite. The open circuit voltage depends on the light level, but for light levels higher than extremely low levels, it is nearly constant.

#### Dark current: ID

The dark current is a small current which flows when a reverse voltage is applied to a photodiode even in dark state. This is a major source of noise for cases in which a reverse voltage is applied to photodiodes (PIN photodiode, etc.).

#### ▶ Shunt resistance: Rsh

The voltage-to-current ratio in the vicinity of 0 V in photodiodes. The shunt resistance is defined as follows: Where ID is the dark current at VR=10 mV.

$$Rsh \left[\Omega\right] = \frac{0.01 \left[V\right]}{Io \left[A\right]}$$

For applications where no reverse voltage is applied, noise resulting from the shunt resistance becomes predominant.

#### ▶ Terminal capacitance: Ct

An effective capacitor is formed at the PN junction of a photodiode. Its capacitance is termed the junction capacitance and is one of parameters that determine the response speed of the photodiode. And it probably causes a phenomenon of gain peaking in I/V converter using operational amplifier. In Hamamatsu, the terminal capacitance including this junction capacitance plus package stray capacitance is listed.

#### ▶ Rise time: tr

This is the measure of the time response of a photodiode to a stepped light input, and is defined as the time required for the output to change from 10% to 90% of the maximum light level (steady output level).

#### ▶ Cutoff frequency: fc

The frequency at which the photodiode output decreases by 3 dB from the output in the frequency region where the output is constant. The rise time (tr) has a relation with the cut-off frequency (fc) as follows:

$$tr[s] = \frac{0.35}{fc[Hz]}$$

#### ▶ NEP (noise equivalent power)

The NEP is the amount of light equivalent to the noise level of a device. It is the light level required to obtain a signal-to-noise ratio of unity. Our data sheets show the NEP values measured at the peak wavelength  $\lambda p$ . Since the noise level is proportional to the square root of the frequency bandwidth, the NEP is measured at a bandwidth of 1 Hz.

NEP [W/Hz<sup>1/2</sup>] = 
$$\frac{\text{Noise current [A/Hz^{1/2}]}}{\text{Photosensitivity [A/W] at } \lambda p}$$

#### Maximum reverse voltage: VR max

Applying a reverse voltage to a photodiode triggers a breakdown at a certain voltage and causes severe deterioration of the device performance. Therefore the absolute maximum rating is specified for reverse voltage at the voltage somewhat lower than this breakdown voltage. The reverse voltage shall not exceed the maximum rating, even instantaneously.

#### Reference (Physical constants related to light and opto-semiconductors)

Constant	Symbol	Value	Unit
Electron charge	q	1.602 × 10 <sup>-19</sup>	С
Speed of light in vacuum	С	$2.998 \times 10^{8}$	m/s
Planck's constant	h	$6.626 \times 10^{-34}$	J·s
Boltzmann's constant	k	1.381 × 10 <sup>-23</sup>	J/K
Thermal energy at room temperature	kT	0.0259 (300 K)	eV
Energy of 1 eV	eV	$1.602 \times 10^{-19}$	J
Wavelength equivalent to 1 eV in vacuum	_	1240	nm
Permittivity of vacuum	60	8.854 × 10 <sup>-12</sup>	F/m
Relative premittivity of silicon	εsi	Approx. 12	_
Relative premittivity of silicon oxide film	кох	Approx. 4	_
Band gap energy of silicon	Eg	Approx. 1.12 (25 °C)	eV

# Precautions against UV light exposure

- ① When UV light irradiation is applied, the product characteristics may degrade. Such examples include degradation of the product's UV sensitivity and increase in dark current. This phenomenon varies depending on the irradiation level, irradiation intensity, usage time, and ambient environment and also varies depending on the product model. Before employing the product, we recommend that you check the tolerance under the ultraviolet light environment that the product will be used in.
- ② Exposure to UV light may cause the characteristics to degrade due to gas released from the resin bonding the product's component materials. As such, we recommend that you avoid applying UV light directly on the resin and apply it on only the inside of the photosensitive area by using an aperture or the like.

#### Related information

www.hamamatsu.com/sp/ssd/doc\_en.html

- Precautions
- Disclaimer
- Metal, ceramic, plastic package products
- Unsealed products
- Surface mount type products

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#### Imaging and processing systems

Cameras / Image processing measuring systems X-ray products Life science systems Medical systems Semiconductor failure analysis systems FPD / LED characteristic evaluation systems Spectroscopic and optical measurement systems

#### Laser products

Semiconductor lasers Applied products of semiconductor lasers Solid state lasers

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